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B/O FORM PTO 1595 (1/31/92) Patent and Trademark Office RECORDATION FORM COVER SHEET PATENTS ONLY

HIRA.0224

To the Honorable C	Commissioner of Patents and Trademarks. Ple	ase record the attached original documents or copy thereof.	
1. Name of Conveying Party(ies):		2. Name and Address of Receiving Party(ies):	
KEIICHI SATO AND SUSUMU KUWABATA Additional names of conveying parties attached: Yes No		Name: Hitachi Software Engineering Co., Ltd. Address: 1-43, Suehiro-cho, 1-chome, Tsurumi-ku City: Yokohama-shi, Kanagawa Japan 230-0045	
3. Nature of Conveyance:			
	nt □ Merger Agreement □ Change of Name		
Execution Date: February 4, 2003		·	
 4. (a) Patent Application Number(s): If this document is being filed together with a new application, the execution date of the application is: Additional Numbers Attached. 		4. (b) Patent Numbers:	
5. Name and Address of Party to whom Correspondence Concerning this Document Should be Mailed:		6. Total Number of Applications and Patents Involved: 1	
Name:	Stanley P. Fisher	7. Total Fee: \$40.00 (37 C.F.R. § 3.41)	
Address:	Reed Smith LLP 3110 Fairview Park Dr. Suite 1400 Falls Church, Va. 22042	Enclosed.Authorized to be charged to deposit account.	
		8. Deposit Account Number: 08-1480	
DO NOT USE TH	HIS SPACE	ATTACH DUPLICATE COPY OF THIS PAGE IF PAYING BY DEPOSIT ACCOUNT	
9. Statement and Signature: To the best of my knowledge and belief, the foregoing is true and correct and any attached copy is a true copy of the original document.			
Stanley P. Fisher,	Registration No. 24, 344	March 27, 2006 Luan Carlos A. Marquez, Registration No. 34,072	
Total number of pages comprising cover sheet: 1			

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40.00 OP

Attorney's Docket No). <u>:</u>
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Assignment of Application

WHEREAS, I (WE) Keiichi SATO of c/o Hitachi Software Engineering Co., Ltd.,
4-12-7, Higashishinagawa, Shinagawa-ku, Tokyo 140-0002 Japan and Susumu KUWABATA
of c/o Department of Materials Chemistry Graduate School of Engineering OSAKA
UNIVERSITY, 2-1, Yamada-oka, Suita-shi, Osaka 565-0871 Japan
have invented certain new and useful improvements in:
SEMICONDUCTOR NANOPARTICLE FLUORESCENT REAGENT AND FLUORESCENCE
DETERMINATION METHOD
for which an application for Letters Patent was executed on February 4, 2003
(Application No,filed),and
WHEREAS, HITACHI SOFTWARE ENGINEERING CO., LTD.
(hereinafter referred to as "ASSIGNEE")having a place of business at: 1-43, Suehiro-cho
l-chome, Tsurumi-ku, Yokohama-shi, Kanagawa 230-0045 Japan
s desirous of acquiring the entire right, title and interest in and to said invention and in and to an
Letters Patent that may be granted therefore in the United States and its territorial possessions ar
n any and all foreign countries;

NOW,THEREFORE, in consideration of the sum of FIVE DOLLARS (\$5.00), the receipt whereof is hereby acknowledged, and for other good and valuable consideration, I (WE), by these presents do sell, assign and transfer unto said ASSIGNEE, the full and exclusive right to the said invention in the United States and its territorial possessions and in all foreign countries and the entire right, title and interest in and to any and all Letters Patent which may be granted therefor in the United States and its territorial possessions and in any and all foreign countries and in and to any and all divisions, reissues, continuations, substitutions and renewals thereof.

I (WE) hereby authorize and request the Patent Office Officials in the United States and its territorial possessions and any official of any and all foreign countries to issue any and all of said Letters Patent, when granted, to said ASSIGNEE as the assignee of my (our) entire right, title and interest in and to the same, for the sole use and behoof of said ASSIGNEE, its (his) successors and assigns, to the full end of the term for which said Letters Patent may be granted, as fully and entirely as the same would have been held by me (us) had this Assignment and sale not been made.

PATENT REEL: 017687 FRAME: 0975 Further, I (WE) agree that I (WE) will communicate to said ASSIGNEE or its legal representatives and assigns covenant and any facts known to me (us) respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation, substitute, renewal and reissue applications, execute all necessary assignment papers to cause any and all of said Letter Patent to be issued to said ASSIGNEE, make all rightful oaths, and, generally do everything possible to aid said ASSIGNEE, its (his) successors and assigns, to obtain and enforce proper protection for said invention in the United States and its territorial possessions and in any and all foreign countries.

The undersigned hereby grant(s) the firm of Reed Smith Hazel-& Thomas LLP of 3110 Fairview Park Drive, Suite 1400, Falls Church, Virginia 22042-4503 U.S.A. the power to insert on this assignment any further identification, including the application number and filing date, which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

Date: February 4, 2003

RECORDED: 03/27/2006

Reich Sato

(Signature of inventor) Keiichi SATO

Date: February 4, 2003

(Signature of inventor) Susumu KUWABATA

PATENT REEL: 017687 FRAME: 0976